

said resin components comprising, based on the total weight of the resin components;

55-90 wt% of component A: a polypropylene resin,

5-40 wt% of component B: a polyetheresteramide containing aromatic rings which is derived from

component b1: a polyamide having a number-average molecular weight of from 200 to 5,000 and containing a carboxyl group at each end, and

component b2: an alkylene oxide adduct of bisphenol having a number-average molecular weight of from 300 to 5,000,

3-20 wt% of component C: a polyamide resin, and

1-20 wt% of component D: at least one modified low-molecular weight polypropylene selected from the group consisting of

component d1: an acid-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and an acid value of from 5 to 150,

component d2: a hydroxy-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and a hydroxyl value of from 5 to 150, and

component d3: an ester-modified low-molecular weight polypropylene obtained by partly or wholly esterifying component d1 with a polyoxyalkylene compound and having a number-average molecular weight of from 1,000 to 28,000;

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said stretching being conducted at a temperature lower than the melting point of the polypropylene-resin as component A, said stretching and oxidation of said stretched film generating ultrafine cracks on a surface of said stretched film through which component B as permanent antistatic agent appears and possessing gloss of 60% or below and opaqueness of 83% or above.

3. A synthetic paper which comprises a film obtained by oxidizing the surface of a film obtained by stretching a resin film comprising as the base material a resin composition comprising

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100 parts by weight of resin components and from 10 to 250 parts by weight of component E: fine inorganic particles;

said resin components comprising, based on the total weight of the resin components,

55-90 wt% of component A: a polypropylene resin,

5-40 wt% of component B: a polyetheresteramide containing aromatic rings which is derived from

component b1: a polyamide having a number-average molecular weight of from 200 to 5,000 and containing a carboxyl group at each end, and

component b2: an alkylene oxide adduct of bisphenol having a number-average molecular weight of from 300 to 5,000

3-20 wt% of component C: a polyamide resin, and

1-20 wt% of component D: at least one modified low-molecular weight polypropylene selected from the group consisting of

component d1: an acid-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and an acid value of from 5 to 150,

component d2: a hydroxy-modified low-molecular weight polypropylene having a number-average molecular weight of from 800 to 25,000 and a hydroxyl value of from 5 to 150, and

component d3: an ester-modified low-molecular weight polypropylene obtained by partly or wholly esterifying component d1 with a polyoxyalkylene compound and having a number-average molecular weight of from 1,000 to 28,000;

said stretching being conducted at a temperature lower than the melting point of the polypropylene resin as component A, wherein the stretched resin film has a void content of from 10 to 60% as calculated using the following equation (1):

$$\text{Void content (\%)} = (\rho^{\circ} - \rho) \times 100 / \rho^{\circ} \quad (1)$$

wherein ρ° is a density of the unstretched film, and ρ is a density of the stretched film.

REMARKS

The claims in the application remain 1-20 and 27.

Favorable reconsideration of the application as amended is respectfully requested.